# Model: T40W-600

Product number: A0600-T40W-110-BE (110V) A0600-T40W-230-BE (230V)

#### 1. Function:

T40W series is a plug and play, fully auto dry cabinet which will be stable at 40°C and ≦5%RH. It is especially designed for moisture sensitive SMD packages to comply with J-STD-033B.

#### There are 4 main functions:

1.1 Wider application in resetting the floor life: Moisture sensitivity SMD packages which are exposed to the air and exceed the floor life should be stored in the T40W series for resetting the floor life. (see J-STD-033B table 4-1, 4-3)

For example: If MSD parts of MSD Level 4,5 and 5a are exposed for less than eight hours, they can be stored in a dry cabinet for resetting the floor life. However, if their exposure time is longer than eight hours, the SMD packages should be stored at 40°C in a T40W series to reset the floor life.

- **1.2 Labor saving:** SMD packages shipped in low temperature carriers may not be baked in a traditional high temperature oven with the temperature higher than 40°C, as it will cause deformation of the carriers. Storing in a T40W series, operators do not need to remove the SMD package to thermally safer carriers. It saves labor cost and eliminates the chance of damaging the carriers.
- **1.3 Embedded Alarm:** The temperature or relative humidity of interior cabinet exceeds the preset value will activate the embedded alarm of buzz and flash in the control panel.
- **1.4 Memo Cards:** Special "Slash Cover Sheet" design to allow inseting the memo cards which can record the necessary storage information of MSD management.

#### 2. Features:

- **2.1 Modular Design:** This is a modularly designed dry cabinet. The main modules are display controller, power box, dehumidifier, shelf, caster wheel and cable. All of the modules can be replaced easily.
- 2.2 Green Design: The performance of the dry cabinet can be upgraded by just changing the modules. There will be no waste materials created to pollute the environment. The old modules can be collected and sent back to the maker. Dr.Storage dry cabinets can be used as long as the cabinet structure is in good condition. It means that the product life could last for 10 or 20 years. Thousands of our dry cabinets have been serving their owners for more than 15 years.
- 2.3 Data Recording: It is important to verify that the condition of storage meets the regulation of J-STD-033B. The users can connect note book PCs directly to the RS232 port of the cabinet to acquire the data or use our data logger to record the data. With our data recording function, the historical fluctuation of relative humidity and temperature can be shown clearly in the graph. The floor life of the Moisture Sensitive Devices can also be calculated in the software. This uniquely patented function can easily verify if the SMD packages are stored at proper condition. It is very convenient for those who carry out quality assurance procedures.
- 2.4 Memo Cards: Special "Slash Cover Sheet" design to allow inseting the memo cards which can record the necessary storage information of MSD management.
- 2.5 Calibration Reminding: The drift effect of sensors might influence the accuracy. In order to help complying with the regulation of ISO, a unique design of calibration expiration reminding function is offered in this model. When the sensor runs over 365 days, the decimal point in the panel will be flashed for reminding the user.
- 2.6 Alarm Setting: There are two ways of alert flash and buzz. Alert can be activated when the relative humidity or temperature is higher than the setting of upper limit. And the flash and buzz alert can be activated by different delay time.

### 3. Specifications:

- 3.1 Temperature & Humidity Range: 40±2°C, ≦5%RH
- 3.2 Outside Dimension: W600\*D770\*H1805mm
- 3.3 Capacity: 385L
- 3.4 Shelves: 5 shelves (p/n: A0600-D3-SUS)
- 3.5 Color: black
- 3.6 Voltage: 110V/230V (select voltage in advance)
- 3.7 Display Precision:  $\pm 1.0\,^{\circ}\text{C}, \, \pm 3.0\%\text{RH}$
- 3.8 Software: Humidity Manager V2 for drawing the curve of RH and temperature.
- 3.9 Structure: 1mm thick carbon steel with antistatic paint.
- 3.10 Door: Compression handles, airtight magnetic sealers and antistatic glass.
- 3.11 Wheel: 4 antistatic 3" wheels, two of them with brakes.
- 3.12 Grounding Wire:  $1M\Omega$ . (940mm long) 3.13 ESD Paint:  $10^3 \sim 10^9 \Omega$ . (surface resistance) 3.14 Power Consumption: Max. 600W; Ave. 300Wh
- 3.15 Baking 40°C Dry Cabinet is suitable for ambient temperature >15°C.



pic 1



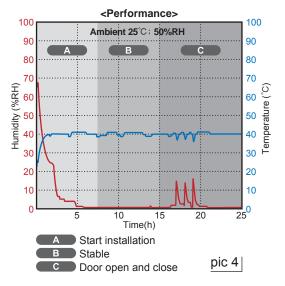
Control Panel

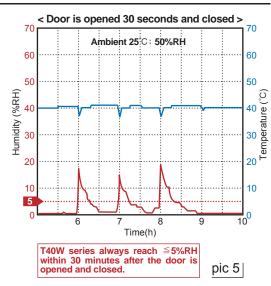
pic 2



Memo Cards

pic 3

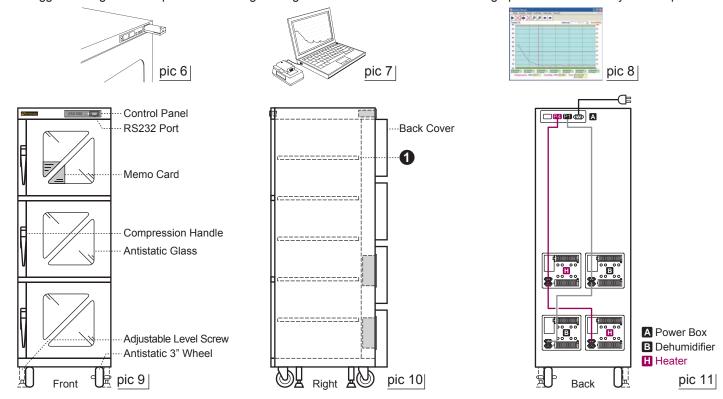




### 4. Additional options:

Traditional options.								
Item	0	2		3	4			
Product Number	A0600-D3-SUS (stainless)	DL-5	DL-5-1	DLR-5	LOG-S3.0			
Product Name	Shelf	Data Logger		Data Reader	Humidity Manager V3			
Description	W500*D480*H20mm	3,900 records.	40,000 records.	Data reader can transfer the records of data logger to PC through the USB.	It can calculate floor life of Moisture Sensitive Devices.			
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2 Data Logger → Plug in RS232 port → Recording → Plug in data reader → Software draws a graph of relative humidity and temperature.



## **IPC/JEDEC J-STD-033B**

Table 4-1 Reference Conditions for Drying Mounted or Unmounted SMD Packages (User Bake: Floor life begins counting at time = 0 after bake)

		Bake @ 125°C		Bake @ 90°C ≦5% RH		Bake @ 40°C ≦5% RH	
Package Body	Level	Exceeding Floor Life by >72 h	Exceeding Floor Life by≦72 h	Exceeding Floor Life by >72 h	Exceeding Floor Life by≦72 h	Exceeding Floor Life by >72 h	Exceeding Floor Life by≦72 h
Thickness	2	5 hours	3 hours	17 hours	11 hours	8 days	5 days
≦1.4 mm	2a	7 hours	5 hours	23 hours	13 hours	9 days	7 days
	3	9 hours	7 hours	33 hours	23 hours	13 days	9 days
	4	11 hours	7 hours	37 hours	23 hours	15 days	9 days
	5	12 hours	7 hours	41 hours	24 hours	17 days	10 days
	5a	16 hours	10 hours	54 hours	24 hours	22 days	10 days
Thickness	2	18 hours	15 hours	63 hours	2 days	25days	20 days
>1.4 mm ≦2.0 mm	2a	21 hours	16 hours	3 days	2 days	29 days	22 days
_ <b>2.0</b> IIIII	3	27 hours	17 hours	4 days	2 days	37 days	23 days
	4	34 hours	20 hours	5 days	3 days	47 days	28 days
	5	40 hours	25 hours	6 days	4 days	57 days	35 days
	5a	48 hours	40 hours	8 days	6 days	79 days	56 days
Thickness	2	48 hours	48 hours	10 days	7 days	79 days	67 days
>2.0 mm ≦4.5 mm	2a	48 hours	48 hours	10 days	7 days	79 days	67 days
=4.5 111111	3	48 hours	48 hours	10 days	8 days	79 days	67 days
	4	48 hours	48 hours	10 days	10 days	79 days	67 days
	5	48 hours	48 hours	10 days	10 days	79 days	67 days
	5a	48 hours	48 hours	10 days	10 days	79 days	67 days
BGA package >17 mm x 17 mm or any stacked die package (See Note 2)	2-6	96 hours	As above per package thickness and moisture level	Not applicable	As above per package thickness and moisture level	Not applicable	As above per package thickness and moisture level

Note 1: Table 4-1 is based on worst-case molded lead frame SMD packages. Users may reduce the actual bake time if technically justified (e.g., absorption/desorption data, etc.). In most cases it is applicable to other nonhermetic surface mount SMD packages.

Note 3: If baking of packages >4.5 mm thick is required see appendix B.

Table 4-3 Resetting or Pausing the "Floor Life" Clock at User Site

MSL Level	Exposure Time @ Temp/Humidity	Floor Life	Desiccator Time @ Relative Humidity	Bake	Reset Shelf Life
2, 2a, 3, 4, 5, 5a	Anytime ≦40°C/85% RH	reset	NA	Table 4.1	Dry Pack
2, 2a, 3, 4, 5, 5a	> floor life ≦30°C/60% RH	reset	NA	Table 4.1	Dry Pack
2a, 3, 4	>12 hrs ≦30°C/60% RH	reset	NA	Table 4.1	Dry Pack
2, 2a, 3, 4	≦12 hrs ≦30°C/60% RH	reset	5X exposure time ≦10% RH	NA	NA
5, 5a	>8 hrs ≦30°C/60% RH	reset	NA	Table 4.1	Dry Pack
5, 5a	≦8 hrs ≦30°C/60% RH	reset	10X exposure time ≤ 5% RH	NA	NA
2, 2a, 3	Cumulative time ≧ floor life ≤30°C/60% RH	pause	Anytime ≦10% RH	NA	NA

according to IPC/JEDEC J-STD-033B



Note 2: For BGA packages >17 mm x 17 mm, that do not have internal planes that block the moisture diffusion path in the substrate, may use bake times based on the thickness/moisture level portion of the table.